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501.36931CX2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): T. Iwasaki, et al.
Application. No. 09/255,856
Filed: February 23, 1999
For: SEMICONDUCTOR DEVICE WITH LAYERED
INTERCONNECT STRUCTURE
Group: 2813
Examiner: S. Smoot

NOTICE OF APPEAL FROM THE PRIMARY

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

November 23, 2004

Sir:

In accordance with the provisions of 37 CFR 1.191, Applicants hereby appeal from the final rejection as set forth in the Final Office Action mailed June 23, 2004, finally rejecting claims 4, 9, 10, 16-20, 22-25, 27-31 and 33-37.

A Credit Card Payment form in the amount of \$340.00 is enclosed, to cover the Appeal Fee.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

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William I. Solomon
Registration No. 28,565

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